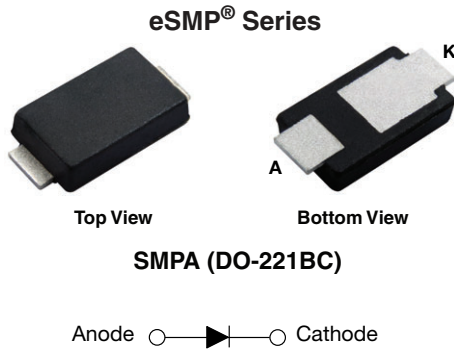


Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier



FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



3D Models

| PRIMARY CHARACTERISTICS | |
|--|-----------------|
| $I_{F(AV)}$ | 8.0 A |
| V_{RRM} | 100 V |
| I_{FSM} | 90 A |
| V_F at $I_F = 8.0$ A ($T_J = 125$ °C) | 0.63 V |
| T_J max. | 175 °C |
| Package | SMPA (DO-221BC) |
| Circuit configuration | Single |

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

MECHANICAL DATA

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | |
|--|----------------------------|-------------|------|
| PARAMETER | SYMBOL | V8PAM103S | UNIT |
| Device marking code | | 8MGS | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 100 | V |
| Maximum DC forward current | $I_{F(AV)}$ ⁽¹⁾ | 8.0 | A |
| | $I_{F(AV)}$ ⁽²⁾ | 2.8 | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I_{FSM} | 90 | A |
| Operating junction temperature range | T_J ⁽³⁾ | -40 to +175 | °C |
| Storage temperature range | T_{STG} | -55 to +175 | °C |

Notes

(1) Units mounted on 3 cm x 3 cm aluminum PCB

(2) Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB

(3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | | |
|---|----------------------|-----------------------------------|-------------|-------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | $I_F = 4.0\text{ A}$ | $T_J = 25\text{ }^\circ\text{C}$ | $V_F^{(1)}$ | 0.6 | - | V |
| | $I_F = 8.0\text{ A}$ | | | 0.73 | 0.8 | |
| | $I_F = 4.0\text{ A}$ | $T_J = 125\text{ }^\circ\text{C}$ | | 0.53 | - | |
| | $I_F = 8.0\text{ A}$ | | | 0.63 | 0.7 | |
| Reverse current | $V_R = 70\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$ | $I_R^{(2)}$ | 0.002 | - | mA |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 1 | - | |
| | $V_R = 100\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$ | | - | 0.14 | |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 2 | 8 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | C_J | 770 | - | pF |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width $\leq 5\text{ ms}$

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified) | | | |
|--|--------------------------|-----------|--------------------|
| PARAMETER | SYMBOL | V8PAM103S | UNIT |
| Typical thermal resistance | $R_{\theta JA}^{(1)(2)}$ | 100 | $^\circ\text{C/W}$ |
| | $R_{\theta JM}^{(3)}$ | 5 | |

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
(3) Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V8PAM103S-M3/H | 0.032 | H | 3500 | 7" diameter plastic tape and reel |
| V8PAM103S-M3/I | 0.032 | I | 14 000 | 13" diameter plastic tape and reel |
| V8PAM103SHM3/H ⁽¹⁾ | 0.032 | H | 3500 | 7" diameter plastic tape and reel |
| V8PAM103SHM3/I ⁽¹⁾ | 0.032 | I | 14 000 | 13" diameter plastic tape and reel |

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified)

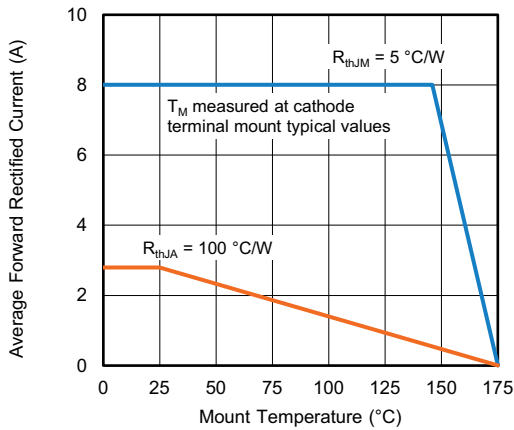


Fig. 1 - Maximum Forward Current Derating Curve

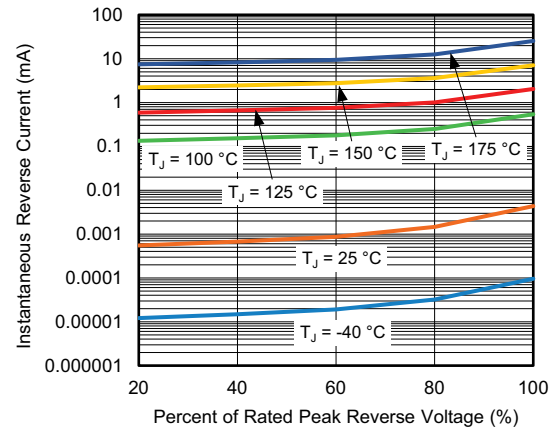


Fig. 4 - Typical Reverse Leakage Characteristics

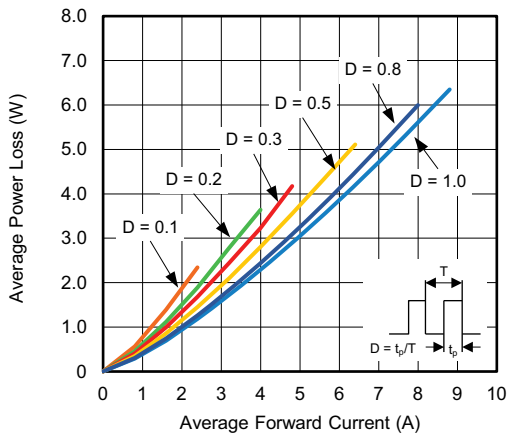


Fig. 2 - Forward Power Loss Characteristics

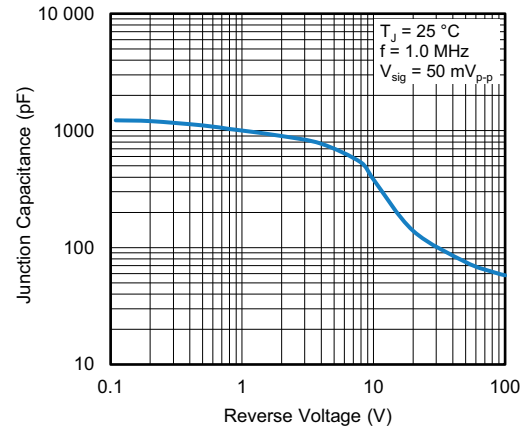


Fig. 5 - Typical Junction Capacitance

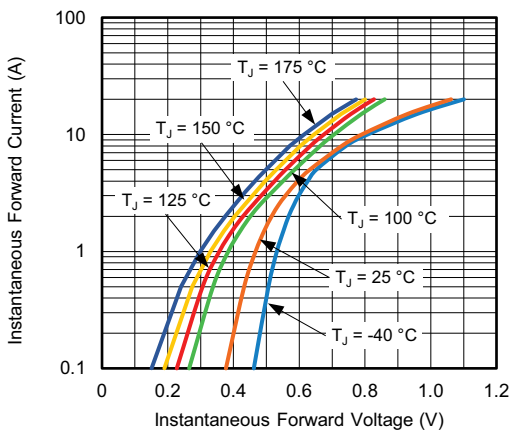


Fig. 3 - Typical Instantaneous Forward Characteristics

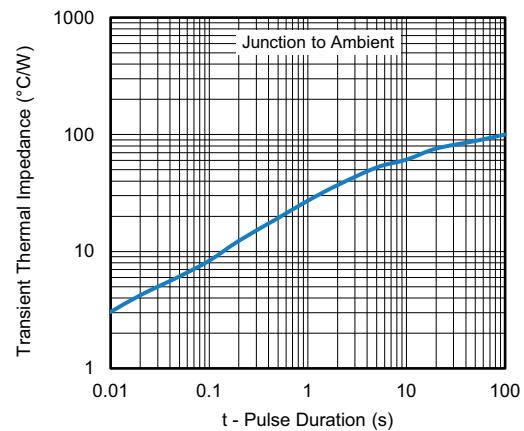


Fig. 6 - Typical Transient Thermal Impedance

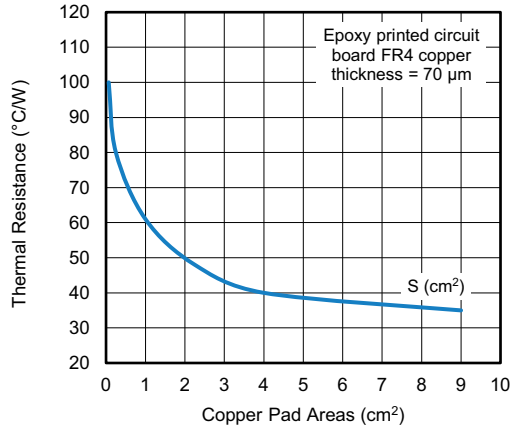
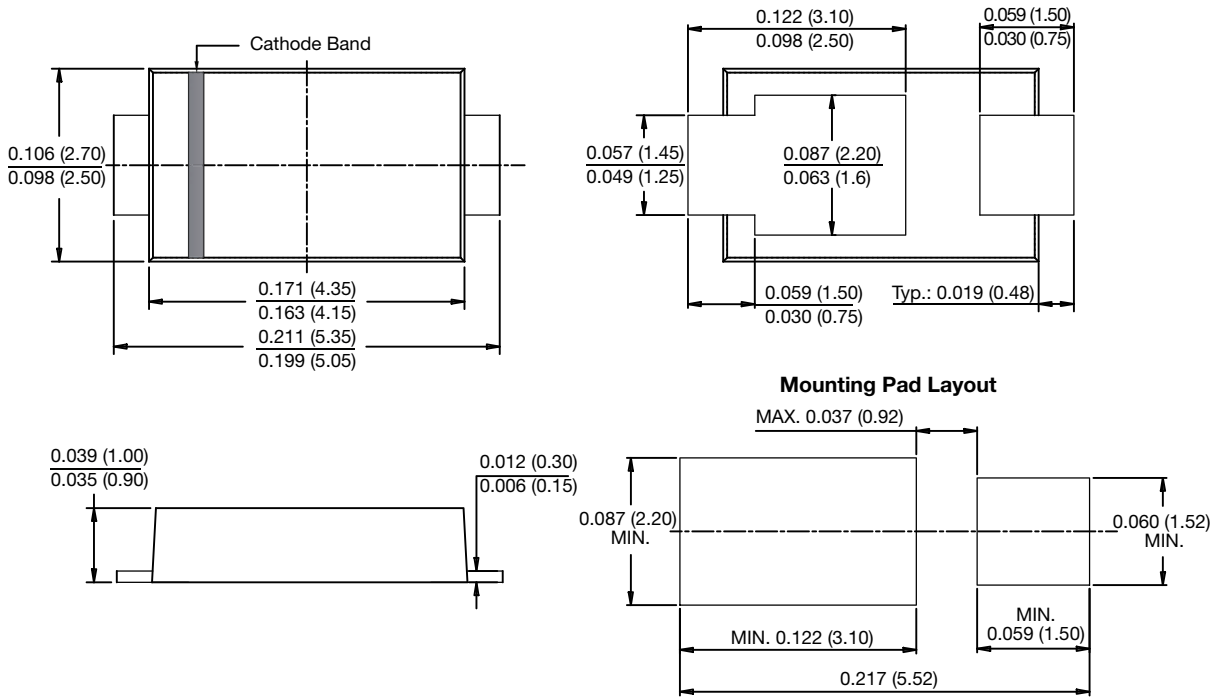


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPA (DO-221BC)





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